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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

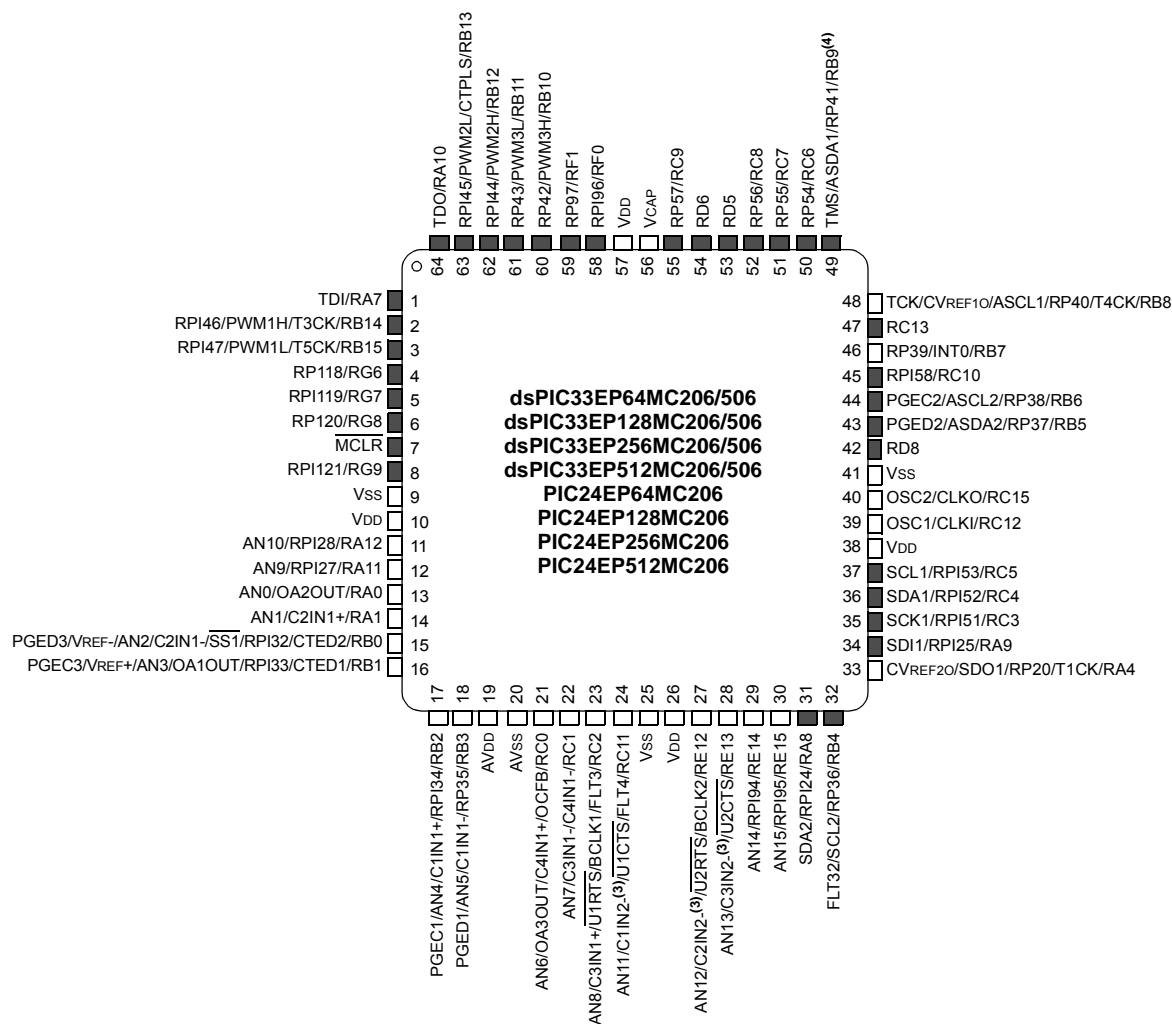
#### Details

Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	70 MIPS
Connectivity	CANbus, I <sup>2</sup> C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	35
Program Memory Size	64KB (22K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 16
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 9x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-UQFN Exposed Pad
Supplier Device Package	48-UQFN (6x6)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep64gp504t-i-mv">https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep64gp504t-i-mv</a>

## Pin Diagrams (Continued)

64-Pin TQFP<sup>(1,2,3)</sup>

■ = Pins are up to 5V tolerant



- Note**
- 1: The RPN/RPIn pins can be used by any remappable peripheral with some limitation. See **Section 11.4 “Peripheral Pin Select (PPS)”** for available peripherals and for information on limitations.
  - 2: Every I/O port pin (RAX-RGX) can be used as a Change Notification pin (CNAX-CNGX). See **Section 11.0 “I/O Ports”** for more information.
  - 3: The metal pad at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.
  - 4: There is an internal pull-up resistor connected to the TMS pin when the JTAG interface is active. See the JTAGEN bit field in Table 27-2.



FIGURE 2-5: SINGLE-PHASE SYNCHRONOUS BUCK CONVERTER

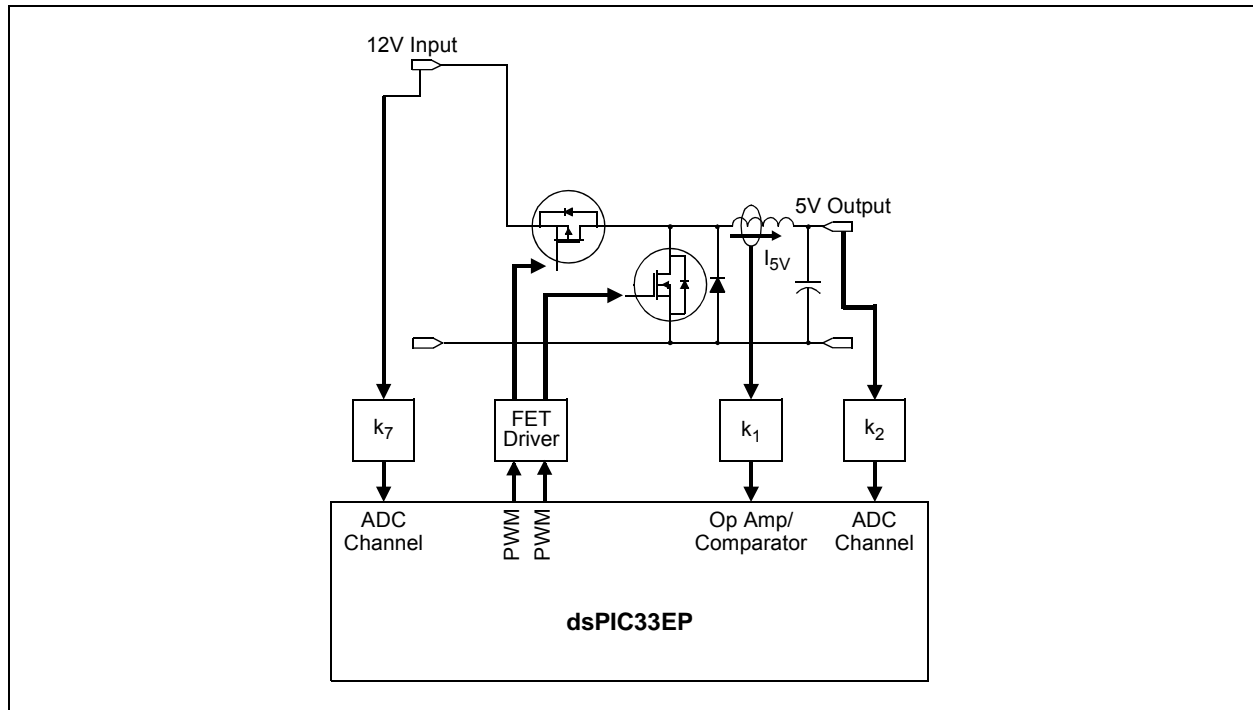
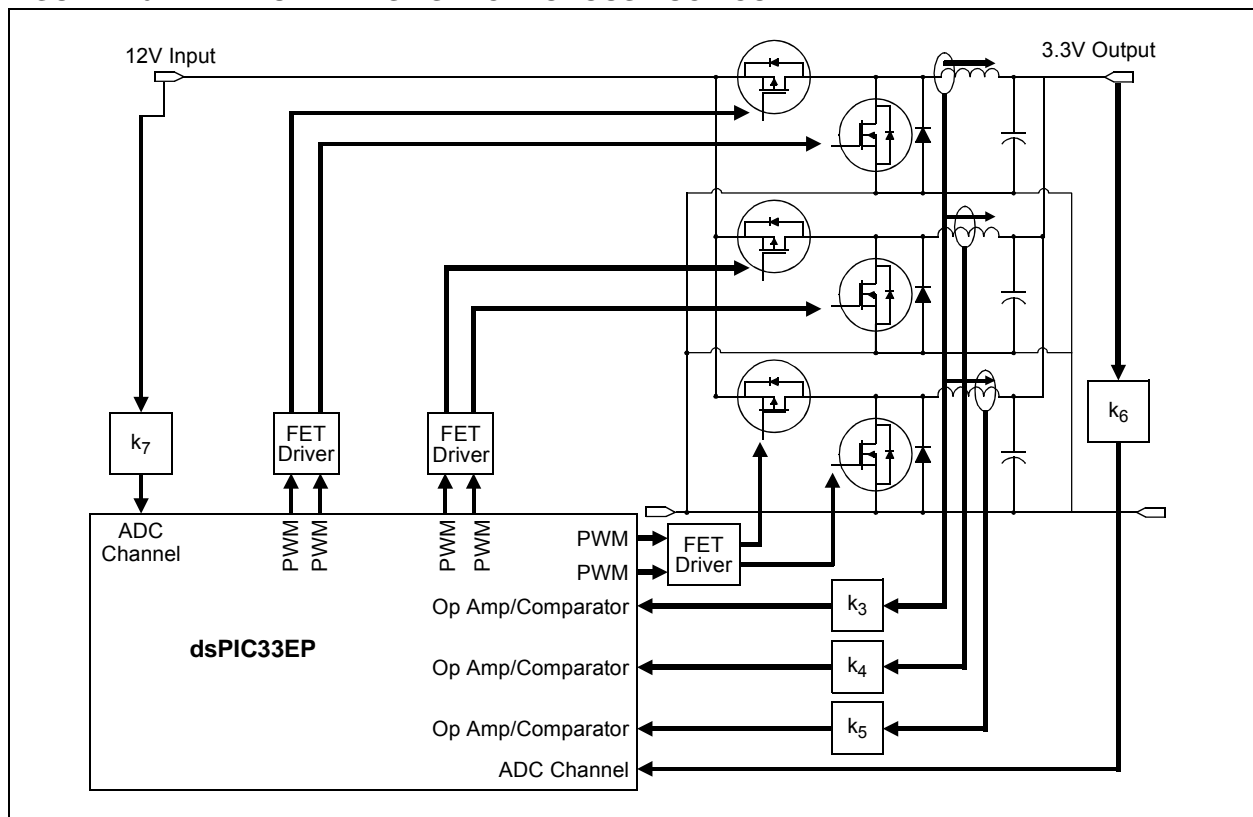


FIGURE 2-6: MULTIPHASE SYNCHRONOUS BUCK CONVERTER



**TABLE 4-7: INTERRUPT CONTROLLER REGISTER MAP FOR dsPIC33EPXXXMC50X DEVICES ONLY (CONTINUED)**

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
IPC23	086E	—	PWM2IP<2:0>			—	PWM1IP<2:0>			—	—	—	—	—	—	—	—	4400
IPC24	0870	—	—	—	—	—	—	—	—	—	—	—	—	—	PWM3IP<2:0>			0004
IPC35	0886	—	JTAGIP<2:0>			—	ICDIP<2:0>			—	—	—	—	—	—	—	—	4400
IPC36	0888	—	PTG0IP<2:0>			—	PTGWDTIP<2:0>			—	PTGSTEPIP<2:0>			—	—	—	—	4440
IPC37	088A	—	—	—	—	—	PTG3IP<2:0>			—	PTG2IP<2:0>			—	PTG1IP<2:0>			0444
INTCON1	08C0	NSTDIS	OVAERR	OVBERR	COVAERR	COVBERR	OVATE	OVBTE	COVTE	SFTACERR	DIV0ERR	DMACERR	MATHERR	ADDRERR	STKERR	OSCFail	—	0000
INTCON2	08C2	GIE	DISI	SWTRAP	—	—	—	—	—	—	—	—	—	—	INT2EP	INT1EP	INT0EP	8000
INTCON3	08C4	—	—	—	—	—	—	—	—	—	—	DAE	DOOVR	—	—	—	—	0000
INTCON4	08C6	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	SGHT	0000
INTTREG	08C8	—	—	—	—	ILR<3:0>				VECNUM<7:0>								0000

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-23: ECAN1 REGISTER MAP WHEN WIN (C1CTRL1<0>) = 1 FOR dsPIC33EPXXXMC/GP50X DEVICES ONLY**

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets	
	0400-041E	See definition when WIN = x																	
C1BUFPNT1	0420	F3BP<3:0>				F2BP<3:0>				F1BP<3:0>				F0BP<3:0>				0000	
C1BUFPNT2	0422	F7BP<3:0>				F6BP<3:0>				F5BP<3:0>				F4BP<3:0>				0000	
C1BUFPNT3	0424	F11BP<3:0>				F10BP<3:0>				F9BP<3:0>				F8BP<3:0>				0000	
C1BUFPNT4	0426	F15BP<3:0>				F14BP<3:0>				F13BP<3:0>				F12BP<3:0>				0000	
C1RXM0SID	0430	SID<10:3>								SID<2:0>			—	MIDE	—	EID<17:16>		xxxx	
C1RXM0EID	0432	EID<15:8>								EID<7:0>								xxxx	
C1RXM1SID	0434	SID<10:3>								SID<2:0>			—	MIDE	—	EID<17:16>		xxxx	
C1RXM1EID	0436	EID<15:8>								EID<7:0>								xxxx	
C1RXM2SID	0438	SID<10:3>								SID<2:0>			—	MIDE	—	EID<17:16>		xxxx	
C1RXM2EID	043A	EID<15:8>								EID<7:0>								xxxx	
C1RXF0SID	0440	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF0EID	0442	EID<15:8>								EID<7:0>								xxxx	
C1RXF1SID	0444	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF1EID	0446	EID<15:8>								EID<7:0>								xxxx	
C1RXF2SID	0448	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF2EID	044A	EID<15:8>								EID<7:0>								xxxx	
C1RXF3SID	044C	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF3EID	044E	EID<15:8>								EID<7:0>								xxxx	
C1RXF4SID	0450	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF4EID	0452	EID<15:8>								EID<7:0>								xxxx	
C1RXF5SID	0454	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF5EID	0456	EID<15:8>								EID<7:0>								xxxx	
C1RXF6SID	0458	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF6EID	045A	EID<15:8>								EID<7:0>								xxxx	
C1RXF7SID	045C	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF7EID	045E	EID<15:8>								EID<7:0>								xxxx	
C1RXF8SID	0460	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF8EID	0462	EID<15:8>								EID<7:0>								xxxx	
C1RXF9SID	0464	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF9EID	0466	EID<15:8>								EID<7:0>								xxxx	
C1RXF10SID	0468	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	
C1RXF10EID	046A	EID<15:8>								EID<7:0>								xxxx	
C1RXF11SID	046C	SID<10:3>								SID<2:0>			—	EXIDE	—	EID<17:16>		xxxx	

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

### 7.3 Interrupt Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

**Note:** In the event you are not able to access the product page using the link above, enter this URL in your browser:  
<http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464>

#### 7.3.1 KEY RESOURCES

- “**Interrupts**” (DS70600) in the “*dsPIC33/PIC24 Family Reference Manual*”
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related “*dsPIC33/PIC24 Family Reference Manual*” Sections
- Development Tools

### 7.4 Interrupt Control and Status Registers

dsPIC33EPXXXGP50X, dsPIC33EPXXXMC20X/50X and PIC24EPXXXGP/MC20X devices implement the following registers for the interrupt controller:

- INTCON1
- INTCON2
- INTCON3
- INTCON4
- INTTREG

#### 7.4.1 INTCON1 THROUGH INTCON4

Global interrupt control functions are controlled from INTCON1, INTCON2, INTCON3 and INTCON4.

INTCON1 contains the Interrupt Nesting Disable bit (NSTDIS), as well as the control and status flags for the processor trap sources.

The INTCON2 register controls external interrupt request signal behavior and also contains the Global Interrupt Enable bit (GIE).

INTCON3 contains the status flags for the DMA and DO stack overflow status trap sources.

The INTCON4 register contains the software generated hard trap status bit (SGHT).

#### 7.4.2 IFSx

The IFSx registers maintain all of the interrupt request flags. Each source of interrupt has a status bit, which is set by the respective peripherals or external signal and is cleared via software.

#### 7.4.3 IECx

The IECx registers maintain all of the interrupt enable bits. These control bits are used to individually enable interrupts from the peripherals or external signals.

#### 7.4.4 IPCx

The IPCx registers are used to set the Interrupt Priority Level (IPL) for each source of interrupt. Each user interrupt source can be assigned to one of eight priority levels.

#### 7.4.5 INTTREG

The INTTREG register contains the associated interrupt vector number and the new CPU Interrupt Priority Level, which are latched into the Vector Number bits (VECNUM<7:0>) and Interrupt Priority Level bits (ILR<3:0>) fields in the INTTREG register. The new Interrupt Priority Level is the priority of the pending interrupt.

The interrupt sources are assigned to the IFSx, IECx and IPCx registers in the same sequence as they are listed in Table 7-1. For example, the INT0 (External Interrupt 0) is shown as having Vector Number 8 and a natural order priority of 0. Thus, the INT0IF bit is found in IFS0<0>, the INT0IE bit in IEC0<0> and the INT0IP bits in the first position of IPC0 (IPC0<2:0>).

#### 7.4.6 STATUS/CONTROL REGISTERS

Although these registers are not specifically part of the interrupt control hardware, two of the CPU Control registers contain bits that control interrupt functionality. For more information on these registers refer to “**CPU**” (DS70359) in the “*dsPIC33/PIC24 Family Reference Manual*”.

- The CPU STATUS Register, SR, contains the IPL<2:0> bits (SR<7:5>). These bits indicate the current CPU Interrupt Priority Level. The user software can change the current CPU Interrupt Priority Level by writing to the IPLx bits.
- The CORCON register contains the IPL3 bit which, together with IPL<2:0>, also indicates the current CPU priority level. IPL3 is a read-only bit so that trap events cannot be masked by the user software.

All Interrupt registers are described in Register 7-3 through Register 7-7 in the following pages.

**REGISTER 7-7: INTTREG: INTERRUPT CONTROL AND STATUS REGISTER**

U-0	U-0	U-0	U-0	R-0	R-0	R-0	R-0
—	—	—	—	ILR3	ILR2	ILR1	ILR0
bit 15				bit 8			

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
VECNUM7	VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUM0
bit 7				bit 0			

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-12 **Unimplemented:** Read as '0'

bit 11-8 **ILR<3:0>:** New CPU Interrupt Priority Level bits

1111 = CPU Interrupt Priority Level is 15

•  
•  
•

0001 = CPU Interrupt Priority Level is 1

0000 = CPU Interrupt Priority Level is 0

bit 7-0 **VECNUM<7:0>:** Vector Number of Pending Interrupt bits

11111111 = 255, Reserved; do not use

•  
•  
•

00001001 = 9, IC1 – Input Capture 1

00001000 = 8, INT0 – External Interrupt 0

00000111 = 7, Reserved; do not use

00000110 = 6, Generic soft error trap

00000101 = 5, DMAC error trap

00000100 = 4, Math error trap

00000011 = 3, Stack error trap

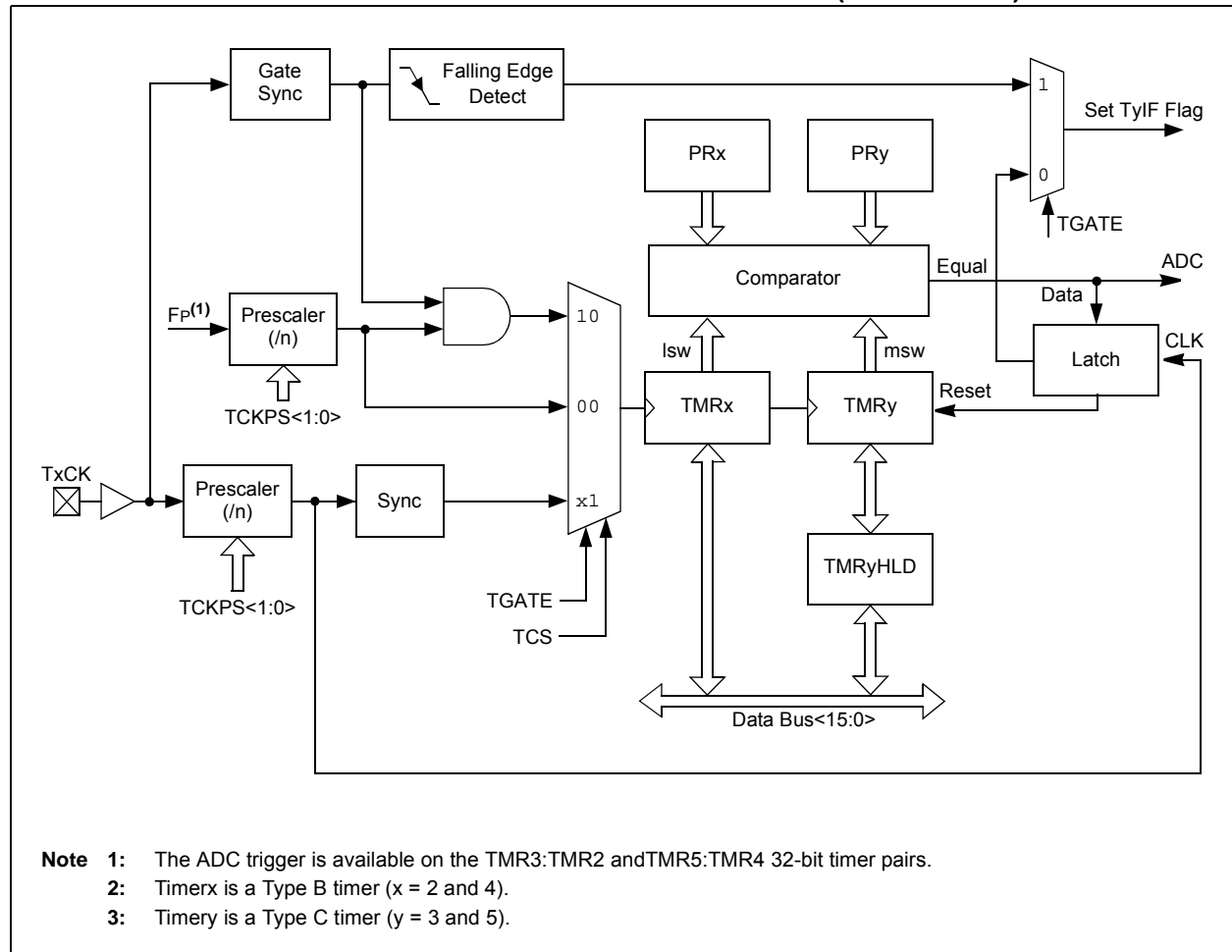
00000010 = 2, Generic hard trap

00000001 = 1, Address error trap

00000000 = 0, Oscillator fail trap



FIGURE 13-3: TYPE B/TIME C TIMER PAIR BLOCK DIAGRAM (32-BIT TIMER)



### 13.1 Timerx/y Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

**Note:** In the event you are not able to access the product page using the link above, enter this URL in your browser:  
<http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464>

#### 13.1.1 KEY RESOURCES

- “Timers” (DS70362) in the “dsPIC33/PIC24 Family Reference Manual”
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related “dsPIC33/PIC24 Family Reference Manual” Sections
- Development Tools

**REGISTER 15-2: OCxCON2: OUTPUT COMPARE x CONTROL REGISTER 2**

R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	R/W-0
FLTMD	FLTOUT	FLTTRIEN	OCINV	—	—	—	OC32
bit 15							bit 8

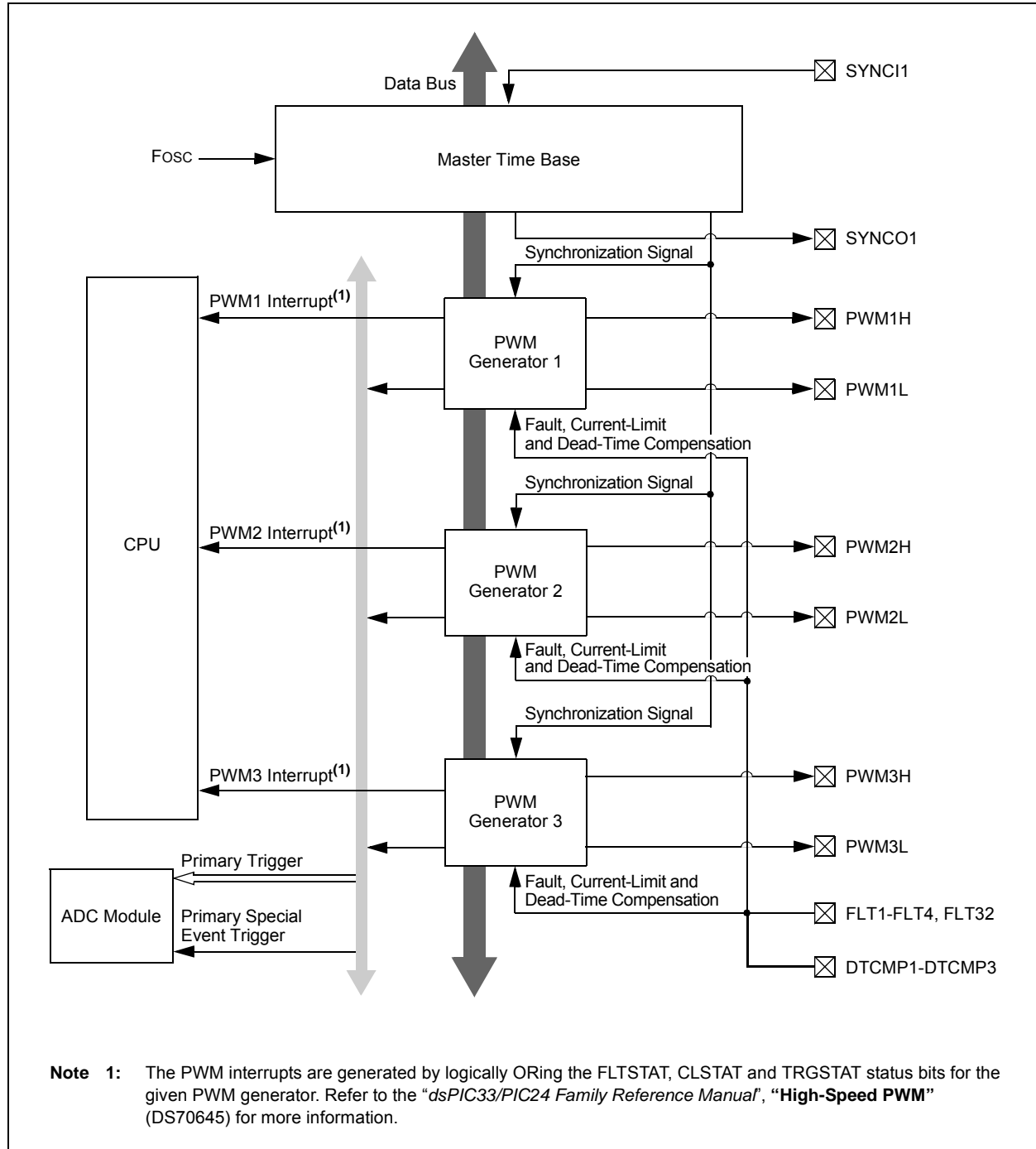
R/W-0	R/W-0, HS	R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0
OCTRIG	TRIGSTAT	OCTRIIS	SYNCSEL4	SYNCSEL3	SYNCSEL2	SYNCSEL1	SYNCSEL0
bit 7							bit 0

<b>Legend:</b>	HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 15 **FLTMD:** Fault Mode Select bit  
 1 = Fault mode is maintained until the Fault source is removed; the corresponding OCFLTx bit is cleared in software and a new PWM period starts  
 0 = Fault mode is maintained until the Fault source is removed and a new PWM period starts
- bit 14 **FLTOUT:** Fault Out bit  
 1 = PWM output is driven high on a Fault  
 0 = PWM output is driven low on a Fault
- bit 13 **FLTTRIEN:** Fault Output State Select bit  
 1 = OCx pin is tri-stated on a Fault condition  
 0 = OCx pin I/O state is defined by the FLTOUT bit on a Fault condition
- bit 12 **OCINV:** Output Compare x Invert bit  
 1 = OCx output is inverted  
 0 = OCx output is not inverted
- bit 11-9 **Unimplemented:** Read as '0'
- bit 8 **OC32:** Cascade Two OCx Modules Enable bit (32-bit operation)  
 1 = Cascade module operation is enabled  
 0 = Cascade module operation is disabled
- bit 7 **OCTRIG:** Output Compare x Trigger/Sync Select bit  
 1 = Triggers OCx from the source designated by the SYNCSELx bits  
 0 = Synchronizes OCx with the source designated by the SYNCSELx bits
- bit 6 **TRIGSTAT:** Timer Trigger Status bit  
 1 = Timer source has been triggered and is running  
 0 = Timer source has not been triggered and is being held clear
- bit 5 **OCTRIIS:** Output Compare x Output Pin Direction Select bit  
 1 = OCx is tri-stated  
 0 = Output Compare x module drives the OCx pin

- Note 1:** Do not use the OCx module as its own Synchronization or Trigger source.
- 2:** When the OCy module is turned OFF, it sends a trigger out signal. If the OCx module uses the OCy module as a Trigger source, the OCy module must be unselected as a Trigger source prior to disabling it.
- 3:** Each Output Compare x module (OCx) has one PTG Trigger/Synchronization source. See **Section 24.0 "Peripheral Trigger Generator (PTG) Module"** for more information.  
 PTGO0 = OC1  
 PTGO1 = OC2  
 PTGO2 = OC3  
 PTGO3 = OC4

FIGURE 16-1: HIGH-SPEED PWMx MODULE ARCHITECTURAL OVERVIEW



**REGISTER 16-7: PWMCONx: PWMx CONTROL REGISTER (CONTINUED)**

bit 7-6	<b>DTC&lt;1:0&gt;</b> : Dead-Time Control bits 11 = Dead-Time Compensation mode 10 = Dead-time function is disabled 01 = Negative dead time is actively applied for Complementary Output mode 00 = Positive dead time is actively applied for all output modes
bit 5	<b>DTCP</b> : Dead-Time Compensation Polarity bit <sup>(3)</sup> <u>When Set to '1':</u> If DTCMPx = 0, PWMxL is shortened and PWMxH is lengthened. If DTCMPx = 1, PWMxH is shortened and PWMxL is lengthened. <u>When Set to '0':</u> If DTCMPx = 0, PWMxH is shortened and PWMxL is lengthened. If DTCMPx = 1, PWMxL is shortened and PWMxH is lengthened.
bit 4	<b>Unimplemented</b> : Read as '0'
bit 3	<b>MTBS</b> : Master Time Base Select bit 1 = PWM generator uses the secondary master time base for synchronization and as the clock source for the PWM generation logic (if secondary time base is available) 0 = PWM generator uses the primary master time base for synchronization and as the clock source for the PWM generation logic
bit 2	<b>CAM</b> : Center-Aligned Mode Enable bit <sup>(2,4)</sup> 1 = Center-Aligned mode is enabled 0 = Edge-Aligned mode is enabled
bit 1	<b>XPRES</b> : External PWMx Reset Control bit <sup>(5)</sup> 1 = Current-limit source resets the time base for this PWM generator if it is in Independent Time Base mode 0 = External pins do not affect PWMx time base
bit 0	<b>IUE</b> : Immediate Update Enable bit <sup>(2)</sup> 1 = Updates to the active MDC/PDCx/DTRx/ALTDTRx/PHASEx registers are immediate 0 = Updates to the active MDC/PDCx/DTRx/ALTDTRx/PHASEx registers are synchronized to the PWMx period boundary

- Note 1:** Software must clear the interrupt status here and in the corresponding IFSx bit in the interrupt controller.
- 2:** These bits should not be changed after the PWMx is enabled (PTEN = 1).
- 3:** DTC<1:0> = 11 for DTCP to be effective; otherwise, DTCP is ignored.
- 4:** The Independent Time Base (ITB = 1) mode must be enabled to use Center-Aligned mode. If ITB = 0, the CAM bit is ignored.
- 5:** To operate in External Period Reset mode, the ITB bit must be '1' and the CLMOD bit in the FCLCONx register must be '0'.

## 17.2 QEI Control Registers

REGISTER 17-1: QE1CON: QE1 CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
QE1EN	—	QE1SIDL	PIMOD2 <sup>(1)</sup>	PIMOD1 <sup>(1)</sup>	PIMOD0 <sup>(1)</sup>	IMV1 <sup>(2)</sup>	IMV0 <sup>(2)</sup>
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	INTDIV2 <sup>(3)</sup>	INTDIV1 <sup>(3)</sup>	INTDIV0 <sup>(3)</sup>	CNTPOL	GATEN	CCM1	CCM0
bit 7							bit 0

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
-n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

- bit 15            **QE1EN:** Quadrature Encoder Interface Module Counter Enable bit  
1 = Module counters are enabled  
0 = Module counters are disabled, but SFRs can be read or written to
- bit 14            **Unimplemented:** Read as '0'
- bit 13            **QE1SIDL:** QE1 Stop in Idle Mode bit  
1 = Discontinues module operation when device enters Idle mode  
0 = Continues module operation in Idle mode
- bit 12-10        **PIMOD<2:0>:** Position Counter Initialization Mode Select bits<sup>(1)</sup>  
111 = Reserved  
110 = Modulo Count mode for position counter  
101 = Resets the position counter when the position counter equals QE1GEC register  
100 = Second index event after home event initializes position counter with contents of QE1IC register  
011 = First index event after home event initializes position counter with contents of QE1IC register  
010 = Next index input event initializes the position counter with contents of QE1IC register  
001 = Every index input event resets the position counter  
000 = Index input event does not affect position counter
- bit 9            **IMV1:** Index Match Value for Phase B bit<sup>(2)</sup>  
1 = Phase B match occurs when QEB = 1  
0 = Phase B match occurs when QEB = 0
- bit 8            **IMV0:** Index Match Value for Phase A bit<sup>(2)</sup>  
1 = Phase A match occurs when QEA = 1  
0 = Phase A match occurs when QEA = 0
- bit 7            **Unimplemented:** Read as '0'

- Note 1:** When CCM<1:0> = 10 or 11, all of the QE1 counters operate as timers and the PIMOD<2:0> bits are ignored.
- 2:** When CCM<1:0> = 00, and QEA and QEB values match the Index Match Value (IMV), the POSCNTNTH and POSCNTL registers are reset. QEA/QEB signals used for the index match have swap and polarity values applied, as determined by the SWPAB and QEAPOL/QEBPOL bits.
- 3:** The selected clock rate should be at least twice the expected maximum quadrature count rate.

### 18.3 SPIx Control Registers

**REGISTER 18-1: SPIxSTAT: SPIx STATUS AND CONTROL REGISTER**

R/W-0	U-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
SPIEN	—	SPISIDL	—	—	SPIBEC<2:0>		
bit 15							bit 8

R/W-0	R/C-0, HS	R/W-0	R/W-0	R/W-0	R/W-0	R-0, HS, HC	R-0, HS, HC
SRMPT	SPIROV	SRXMPT	SISEL2	SISEL1	SISEL0	SPITBF	SPIRBF
bit 7							bit 0

<b>Legend:</b>	C = Clearable bit	HS = Hardware Settable bit	HC = Hardware Clearable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 15      **SPIEN:** SPIx Enable bit  
1 = Enables the module and configures SCKx, SDOx, SDIx and  $\overline{SSx}$  as serial port pins  
0 = Disables the module
- bit 14      **Unimplemented:** Read as '0'
- bit 13      **SPISIDL:** SPIx Stop in Idle Mode bit  
1 = Discontinues the module operation when device enters Idle mode  
0 = Continues the module operation in Idle mode
- bit 12-11      **Unimplemented:** Read as '0'
- bit 10-8      **SPIBEC<2:0>:** SPIx Buffer Element Count bits (valid in Enhanced Buffer mode)  
Master mode:  
Number of SPIx transfers that are pending.  
Slave mode:  
Number of SPIx transfers that are unread.
- bit 7      **SRMPT:** SPIx Shift Register (SPIxSR) Empty bit (valid in Enhanced Buffer mode)  
1 = SPIx Shift register is empty and Ready-To-Send or receive the data  
0 = SPIx Shift register is not empty
- bit 6      **SPIROV:** SPIx Receive Overflow Flag bit  
1 = A new byte/word is completely received and discarded; the user application has not read the previous data in the SPIxBUF register  
0 = No overflow has occurred
- bit 5      **SRXMPT:** SPIx Receive FIFO Empty bit (valid in Enhanced Buffer mode)  
1 = RX FIFO is empty  
0 = RX FIFO is not empty
- bit 4-2      **SISEL<2:0>:** SPIx Buffer Interrupt Mode bits (valid in Enhanced Buffer mode)  
111 = Interrupt when the SPIx transmit buffer is full (SPITBF bit is set)  
110 = Interrupt when last bit is shifted into SPIxSR and as a result, the TX FIFO is empty  
101 = Interrupt when the last bit is shifted out of SPIxSR and the transmit is complete  
100 = Interrupt when one data is shifted into the SPIxSR and as a result, the TX FIFO has one open memory location  
011 = Interrupt when the SPIx receive buffer is full (SPIRBF bit is set)  
010 = Interrupt when the SPIx receive buffer is 3/4 or more full  
001 = Interrupt when data is available in the receive buffer (SRMPT bit is set)  
000 = Interrupt when the last data in the receive buffer is read and as a result, the buffer is empty (SRXMPT bit is set)

**TABLE 30-8: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)**

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended	
Parameter No.	Typ.	Max.	Units	Conditions
<b>Power-Down Current (IPD)<sup>(1)</sup> – dsPIC33EP32GP50X, dsPIC33EP32MC20X/50X and PIC24EP32GP/MC20X</b>				
DC60d	30	100	μA	-40°C
DC60a	35	100	μA	+25°C
DC60b	150	200	μA	+85°C
DC60c	250	500	μA	+125°C
<b>Power-Down Current (IPD)<sup>(1)</sup> – dsPIC33EP64GP50X, dsPIC33EP64MC20X/50X and PIC24EP64GP/MC20X</b>				
DC60d	25	100	μA	-40°C
DC60a	30	100	μA	+25°C
DC60b	150	350	μA	+85°C
DC60c	350	800	μA	+125°C
<b>Power-Down Current (IPD)<sup>(1)</sup> – dsPIC33EP128GP50X, dsPIC33EP128MC20X/50X and PIC24EP128GP/MC20X</b>				
DC60d	30	100	μA	-40°C
DC60a	35	100	μA	+25°C
DC60b	150	350	μA	+85°C
DC60c	550	1000	μA	+125°C
<b>Power-Down Current (IPD)<sup>(1)</sup> – dsPIC33EP256GP50X, dsPIC33EP256MC20X/50X and PIC24EP256GP/MC20X</b>				
DC60d	35	100	μA	-40°C
DC60a	40	100	μA	+25°C
DC60b	250	450	μA	+85°C
DC60c	1000	1200	μA	+125°C
<b>Power-Down Current (IPD)<sup>(1)</sup> – dsPIC33EP512GP50X, dsPIC33EP512MC20X/50X and PIC24EP512GP/MC20X</b>				
DC60d	40	100	μA	-40°C
DC60a	45	100	μA	+25°C
DC60b	350	800	μA	+85°C
DC60c	1100	1500	μA	+125°C

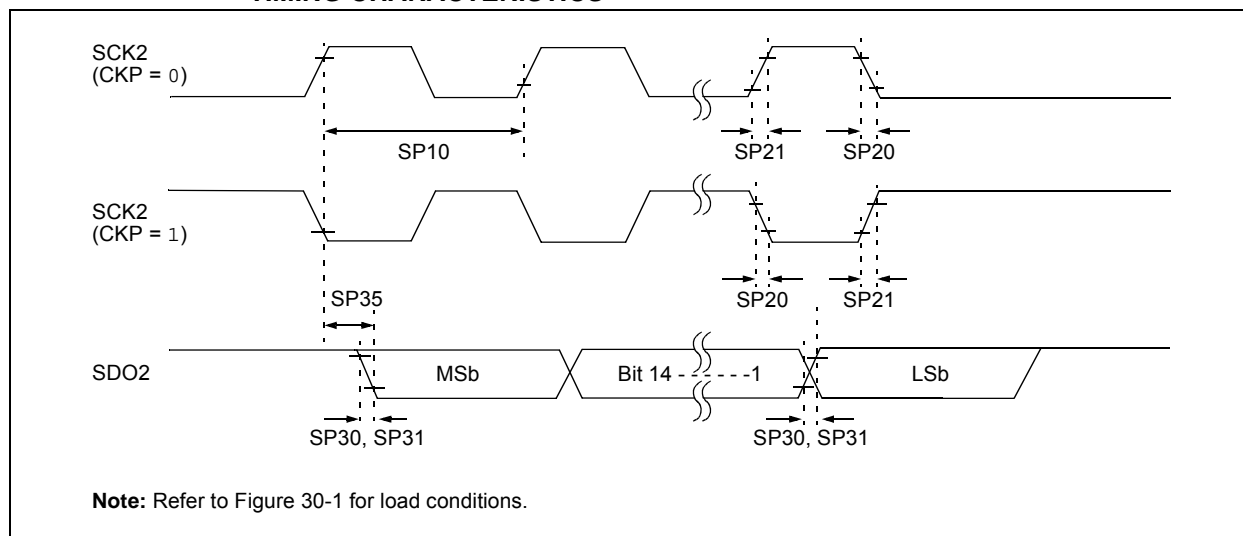
**Note 1:** IPD (Sleep) current is measured as follows:

- CPU core is off, oscillator is configured in EC mode and external clock is active; OSC1 is driven with external square wave from rail-to-rail (EC clock overshoot/undershoot < 250 mV required)
- CLKO is configured as an I/O input pin in the Configuration Word
- All I/O pins are configured as inputs and pulled to VSS
- MCLR = VDD, WDT and FSCM are disabled
- All peripheral modules are disabled (PMDx bits are all set)
- The VREGS bit (RCON<8>) = 0 (i.e., core regulator is set to standby while the device is in Sleep mode)
- The VREGSF bit (RCON<11>) = 0 (i.e., Flash regulator is set to standby while the device is in Sleep mode)
- JTAG is disabled

TABLE 30-33: SPI2 MAXIMUM DATA/CLOCK RATE SUMMARY

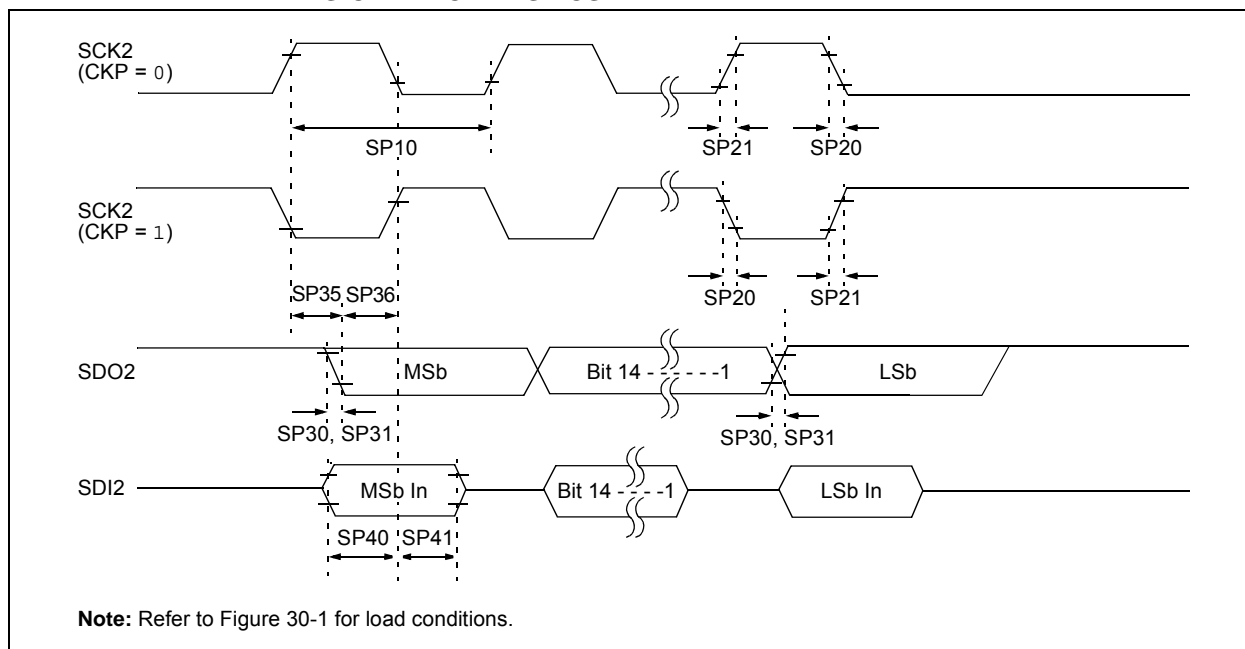
AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for Extended		
Maximum Data Rate	Master Transmit Only (Half-Duplex)	Master Transmit/Receive (Full-Duplex)	Slave Transmit/Receive (Full-Duplex)	CKE	CKP	SMP
15 MHz	Table 30-33	—	—	0,1	0,1	0,1
9 MHz	—	Table 30-34	—	1	0,1	1
9 MHz	—	Table 30-35	—	0	0,1	1
15 MHz	—	—	Table 30-36	1	0	0
11 MHz	—	—	Table 30-37	1	1	0
15 MHz	—	—	Table 30-38	0	1	0
11 MHz	—	—	Table 30-39	0	0	0

FIGURE 30-14: SPI2 MASTER MODE (HALF-DUPLEX, TRANSMIT ONLY, CKE = 0)  
TIMING CHARACTERISTICS





**FIGURE 30-17: SPI2 MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1)**  
**TIMING CHARACTERISTICS**



**TABLE 30-36: SPI2 MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1)**  
**TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param.	Symbol	Characteristic <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units	Conditions
SP10	FscP	Maximum SCK2 Frequency	—	—	9	MHz	-40°C to +125°C (Note 3)
SP20	TscF	SCK2 Output Fall Time	—	—	—	ns	See Parameter DO32 (Note 4)
SP21	TscR	SCK2 Output Rise Time	—	—	—	ns	See Parameter DO31 (Note 4)
SP30	TdoF	SDO2 Data Output Fall Time	—	—	—	ns	See Parameter DO32 (Note 4)
SP31	TdoR	SDO2 Data Output Rise Time	—	—	—	ns	See Parameter DO31 (Note 4)
SP35	Tsch2doV, TscL2doV	SDO2 Data Output Valid after SCK2 Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDO2 Data Output Setup to First SCK2 Edge	30	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDI2 Data Input to SCK2 Edge	30	—	—	ns	
SP41	Tsch2diL, TscL2diL	Hold Time of SDI2 Data Input to SCK2 Edge	30	—	—	ns	

**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typical" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCK2 is 111 ns. The clock generated in Master mode must not violate this specification.

**4:** Assumes 50 pF load on all SPI2 pins.

TABLE 30-49: I2Cx BUS DATA TIMING REQUIREMENTS (MASTER MODE)

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for Extended			
Param No.	Symbol	Characteristic <sup>(4)</sup>		Min. <sup>(1)</sup>	Max.	Units	Conditions
IM10	TLO:SCL	Clock Low Time	100 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			400 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			1 MHz mode <sup>(2)</sup>	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
IM11	THI:SCL	Clock High Time	100 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			400 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			1 MHz mode <sup>(2)</sup>	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
IM20	TF:SCL	SDAx and SCLx Fall Time	100 kHz mode	—	300	ns	Cb is specified to be from 10 to 400 pF
			400 kHz mode	$20 + 0.1 C_b$	300	ns	
			1 MHz mode <sup>(2)</sup>	—	100	ns	
IM21	TR:SCL	SDAx and SCLx Rise Time	100 kHz mode	—	1000	ns	Cb is specified to be from 10 to 400 pF
			400 kHz mode	$20 + 0.1 C_b$	300	ns	
			1 MHz mode <sup>(2)</sup>	—	300	ns	
IM25	TSU:DAT	Data Input Setup Time	100 kHz mode	250	—	ns	
			400 kHz mode	100	—	ns	
			1 MHz mode <sup>(2)</sup>	40	—	ns	
IM26	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	$\mu\text{s}$	
			400 kHz mode	0	0.9	$\mu\text{s}$	
			1 MHz mode <sup>(2)</sup>	0.2	—	$\mu\text{s}$	
IM30	TSU:STA	Start Condition Setup Time	100 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	Only relevant for Repeated Start condition
			400 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			1 MHz mode <sup>(2)</sup>	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
IM31	THD:STA	Start Condition Hold Time	100 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	After this period, the first clock pulse is generated
			400 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			1 MHz mode <sup>(2)</sup>	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
IM33	TSU:STO	Stop Condition Setup Time	100 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			400 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			1 MHz mode <sup>(2)</sup>	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
IM34	THD:STO	Stop Condition Hold Time	100 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			400 kHz mode	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
			1 MHz mode <sup>(2)</sup>	$T_{CY}/2$ (BRG + 2)	—	$\mu\text{s}$	
IM40	TAA:SCL	Output Valid From Clock	100 kHz mode	—	3500	ns	
			400 kHz mode	—	1000	ns	
			1 MHz mode <sup>(2)</sup>	—	400	ns	
IM45	TBF:SDA	Bus Free Time	100 kHz mode	4.7	—	$\mu\text{s}$	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	$\mu\text{s}$	
			1 MHz mode <sup>(2)</sup>	0.5	—	$\mu\text{s}$	
IM50	CB	Bus Capacitive Loading		—	400	pF	
IM51	TPGD	Pulse Gobbler Delay		65	390	ns	(Note 3)

**Note 1:** BRG is the value of the I<sup>2</sup>C™ Baud Rate Generator. Refer to “Inter-Integrated Circuit (I<sup>2</sup>C™)” (DS70330) in the “dsPIC33/PIC24 Family Reference Manual”. Please see the Microchip web site for the latest family reference manual sections.

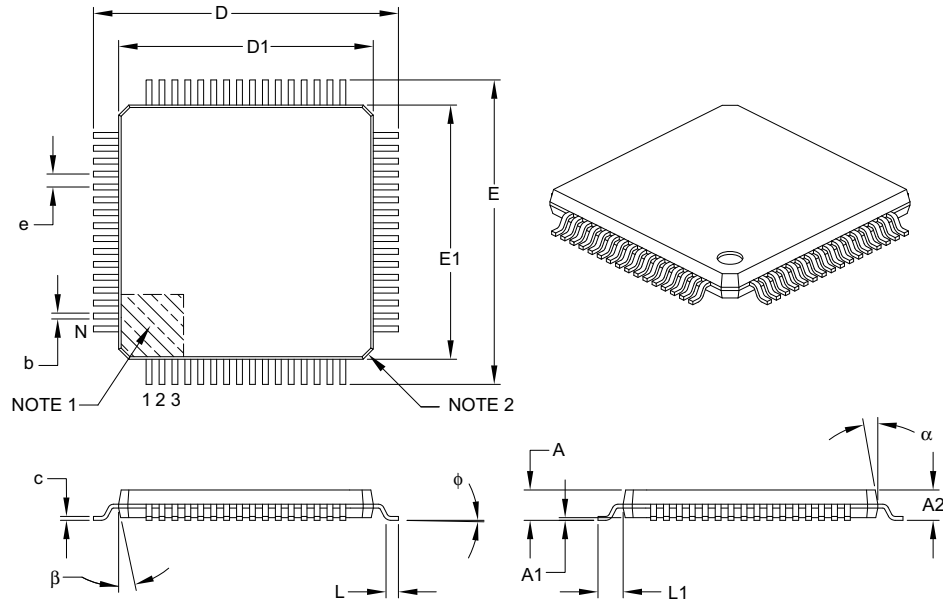
**2:** Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

**3:** Typical value for this parameter is 130 ns.

**4:** These parameters are characterized, but not tested in manufacturing.

**64-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm Footprint [TQFP]**

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Leads	N		64		
Lead Pitch	e		0.50 BSC		
Overall Height	A		–	–	1.20
Molded Package Thickness	A2		0.95	1.00	1.05
Standoff	A1		0.05	–	0.15
Foot Length	L		0.45	0.60	0.75
Footprint	L1		1.00 REF		
Foot Angle	$\phi$		0°	3.5°	7°
Overall Width	E		12.00 BSC		
Overall Length	D		12.00 BSC		
Molded Package Width	E1		10.00 BSC		
Molded Package Length	D1		10.00 BSC		
Lead Thickness	c		0.09	–	0.20
Lead Width	b		0.17	0.22	0.27
Mold Draft Angle Top	$\alpha$		11°	12°	13°
Mold Draft Angle Bottom	$\beta$		11°	12°	13°

**Notes:**

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Chamfers at corners are optional; size may vary.
- Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-085B

**Revision F (November 2012)**

Removed “Preliminary” from data sheet footer.

**Revision G (March 2013)**

This revision includes the following global changes:

- changes “ $\overline{\text{FLT}}\text{x}$ ” pin function to “FLT<sub>x</sub>” on all occurrences
- adds **Section 31.0 “High-Temperature Electrical Characteristics”** for high-temperature (+150°C) data

This revision also includes minor typographical and formatting changes throughout the text.

Other major changes are referenced by their respective section in Table A-5.

**TABLE A-5: MAJOR SECTION UPDATES**

Section Name	Update Description
<b>Cover Section</b>	<ul style="list-style-type: none"> <li>• Changes internal oscillator specification to 1.0%</li> <li>• Changes I/O sink/source values to 12 mA or 6 mA</li> <li>• Corrects 44-pin VTLA pin diagram (pin 32 now shows as 5V tolerant)</li> </ul>
<b>Section 4.0 “Memory Organization”</b>	<ul style="list-style-type: none"> <li>• Deletes references to Configuration Shadow registers</li> <li>• Corrects the spelling of the JTAGIP and PTGWDTIP bits throughout</li> <li>• Corrects the Reset value of all IOCON registers as C000h</li> <li>• Adds footnote to Table 4-42 to indicate the absence of Comparator 3 in 28-pin devices</li> </ul>
<b>Section 6.0 “Resets”</b>	<ul style="list-style-type: none"> <li>• Removes references to cold and warm Resets, and clarifies the initial configuration of the device clock source on all Resets</li> </ul>
<b>Section 7.0 “Interrupt Controller”</b>	<ul style="list-style-type: none"> <li>• Corrects the definition of GIE as “Global Interrupt Enable” (not “General”)</li> </ul>
<b>Section 9.0 “Oscillator Configuration”</b>	<ul style="list-style-type: none"> <li>• Clarifies the behavior of the CF bit when cleared in software</li> <li>• Removes POR behavior footnotes from all control registers</li> <li>• Corrects the tuning range of the TUN&lt;5:0&gt; bits in Register 9-4 to an overall range <math>\pm 1.5\%</math></li> </ul>
<b>Section 13.0 “Timer2/3 and Timer4/5”</b>	<ul style="list-style-type: none"> <li>• Clarifies the presence of the ADC Trigger in 16-bit Timer3 and Timer5, as well as the 32-bit timers</li> </ul>
<b>Section 15.0 “Output Compare”</b>	<ul style="list-style-type: none"> <li>• Corrects the first trigger source for SYNCSEL&lt;4:0&gt; (OCxCON2&lt;4:0&gt;) as OCxRS match</li> </ul>
<b>Section 16.0 “High-Speed PWM Module”</b>	<ul style="list-style-type: none"> <li>• Clarifies the source of the PWM interrupts in Figure 16-1</li> <li>• Corrects the Reset states of IOCONx&lt;15:14&gt; in Register 16-13 as ‘11’</li> </ul>
<b>Section 17.0 “Quadrature Encoder Interface (QEI) Module”</b>	<ul style="list-style-type: none"> <li>• Clarifies the operation of the IMV&lt;1:0&gt; bits (QEICON&lt;9:8&gt;) with updated text and additional notes</li> <li>• Corrects the first prescaler value for QFVDIV&lt;2:0&gt; (QE1IOC&lt;13:11&gt;), now 1:128</li> </ul>
<b>Section 23.0 “10-Bit/12-Bit Analog-to-Digital Converter (ADC)”</b>	<ul style="list-style-type: none"> <li>• Adds note to Figure 23-1 that Op Amp 3 is not available in 28-pin devices</li> <li>• Changes “sample clock” to “sample trigger” in AD1CON1 (Register 23-1)</li> <li>• Clarifies footnotes on op amp usage in Registers 23-5 and 23-6</li> </ul>
<b>Section 25.0 “Op Amp/Comparator Module”</b>	<ul style="list-style-type: none"> <li>• Adds Note text to indicate that Comparator 3 is unavailable in 28-pin devices</li> <li>• Splits Figure 25-1 into two figures for clearer presentation (Figure 25-1 for Op amp/Comparators 1 through 3, Figure 25-2 for Comparator 4). Subsequent figures are renumbered accordingly.</li> <li>• Corrects reference description in xxxxx (now (AVDD+AVSS)/2)</li> <li>• Changes CMSTAT&lt;15&gt; in Register 25-1 to “PSIDL”</li> </ul>
<b>Section 27.0 “Special Features”</b>	<ul style="list-style-type: none"> <li>• Corrects the addresses of all Configuration bytes for 512 Kbyte devices</li> </ul>

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